

## In-situ TEM study of thin-film vanadium oxide stability

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Vanadium oxide thin films were co-deposited via reactive pulsed-dc sputtering onto both formvar-coated Cu TEM grids and SiO<sub>2</sub>-coated Si wafers. A trend was observed throughout the series whereby increasing oxygen partial pressure in the growth chamber caused an increase in both the oxygen content and the disorder in the films [1]. Films deposited below a PO<sub>2</sub> of 5% exhibited the presence of nanocrystals and films deposited above a PO<sub>2</sub> of 5% were amorphous. Two films from the series, one nano-crystalline with an amorphous component, and the other completely amorphous, were found to have the same stoichiometry via rutherford backscattering spectroscopy. Though the bulk stoichiometry of both films was found to be VO<sub>2</sub>, the nanocrystalline phase was determined to be the FCC phase, which at equilibrium is characteristic of VO<sub>x</sub>, where 0.8< x <1.3.

The VO<sub>2</sub> (stoichiometry) films were subjected to annealing in the transmission electron microscope at 350 °C with in-situ observation by both bright-field imaging and electron diffraction, shown in Fig 1. The amorphous film with an O:V ratio of 2:1 transformed to rutile VO<sub>2</sub>, as expected from the equilibrium phase diagram. The nano-crystalline film with an O:V ratio of 2:1 did not transform to crystalline VO<sub>2</sub>, but remained as FCC VO<sub>x</sub>; however, a diffuse low angle scattering feature moved to higher scattering angle. Finally, a nano-crystalline film with an O:V ratio of 0.8:1 remained as FCC VO<sub>x</sub>, as would be expected, and the presence of a diffuse low-angle feature disappeared upon annealing.

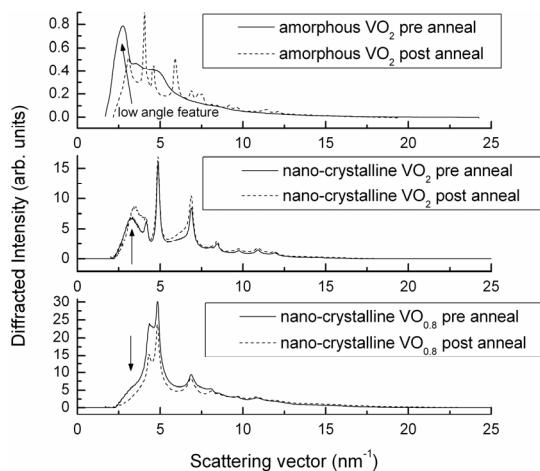
Electron energy loss spectroscopy (EELS) was used to characterize the films both before and after annealing. EEL spectra from the nano-crystalline films before and after annealing are essentially indistinguishable. EELS of the partly-crystallized amorphous film shows the presence of two distinct spectra, one from crystalline regions and one from the amorphous regions, see Figs 3 and 4. The main difference between the two spectra is the presence of near-edge and post-edge structure in the O-k edge. The first difference is a “splitting” of the O-K edge into two distinct peaks. This same near-edge structure is also observed in spectra obtained from VO<sub>2</sub> reference powder. The second distinction between the amorphous and crystalline regions is the presence of an additional feature around 560 eV energy loss, which is found in crystalline spectra and lacking in amorphous spectra. The O K near edge split can be interpreted in terms of crystal field theory [3], and results from degeneracy created in hybridized O2p/V3d orbitals due to interaction between the V states and the octahedrally coordinated O atoms.

Interestingly, the amorphous film that transformed to rutile VO<sub>2</sub> lacks a metal-to-insulator transition (MIT), which is commonly found in VO<sub>2</sub> [2], and results from a phase transformation at 68 °C from a monoclinic structure to the high-temperature rutile structure. The constrained thin-film geometry combined with the residual amorphous phase constrains the film in such a way that the MIT cannot occur. Annealing at 350 °C caused the resistivity of both VO<sub>2</sub> films to increase; however the thermal coefficient of resistance (TCR) was left unchanged for the nano-crystalline VO<sub>x</sub> film while

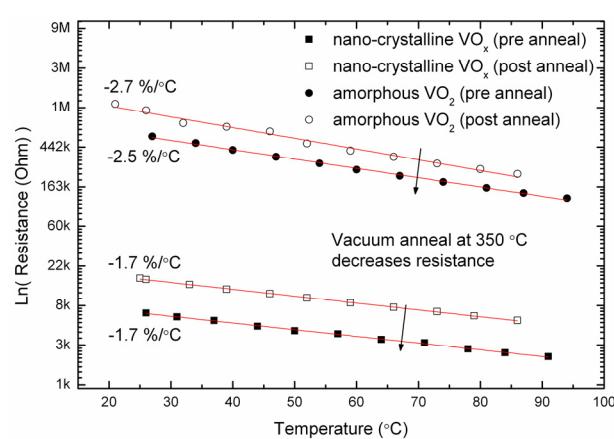
the TCR increased for the film that partially transformed to rutile  $\text{VO}_2$ . It is evident that post process annealing affects both the microstructure and consequently the electrical properties. Future work will focus on elucidating a direct relationship between local atomic order and both resistivity and TCR.

## References

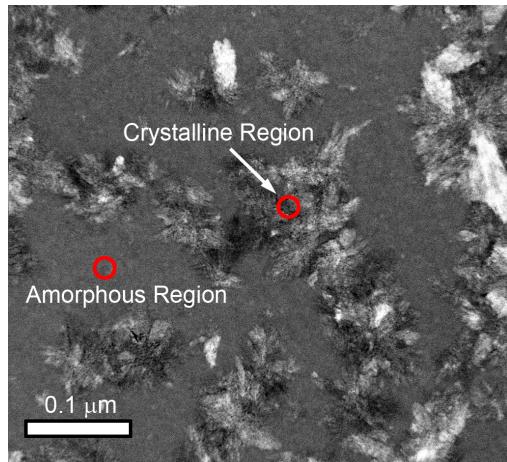
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- [3] M. Willinger, *Investigation of the Oxygen K-Edge Fine Structure in Vanadium Oxides*, Ph.D. Thesis, TU Wien, 2001.



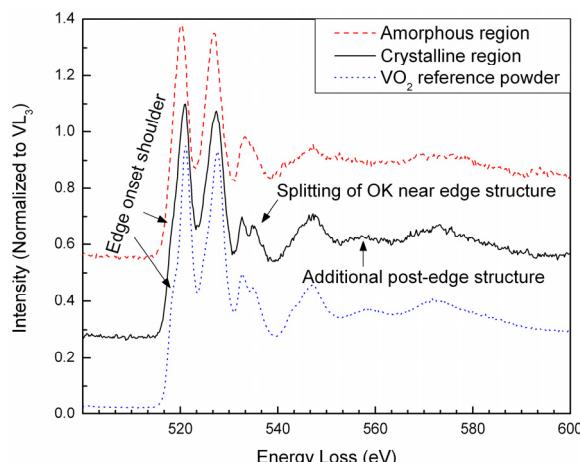
**Fig 1.** Diffracted intensity of both amorphous (5 mTorr 10%) and nano-crystalline (2.5 and 5 mTorr 5%) films before and after in-situ anneal.



**Fig 2.** Resistance of amorphous film and nano-crystalline film before and after anneal as a function of sample temperature.



**Fig 3.** ADF STEM image of partially-crystallized amorphous film showing regions used for EELS spectra shown in Fig 4.



**Fig 4.** EELS spectra showing  $\text{V L}_{2,3}$  edge and  $\text{O K}$  edge. Several differences between amorphous areas and crystalline regions are evident in the  $\text{O K}$  near and post-edge regions.